

/ Descriptions

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/ Features

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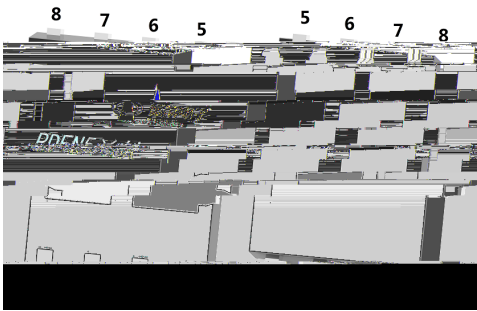
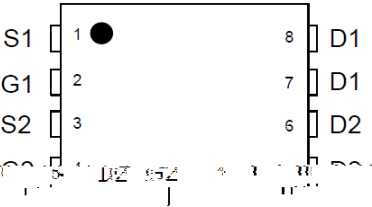
/ Applications

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/ Equivalent Circuit



/ Pinning



/ Marking

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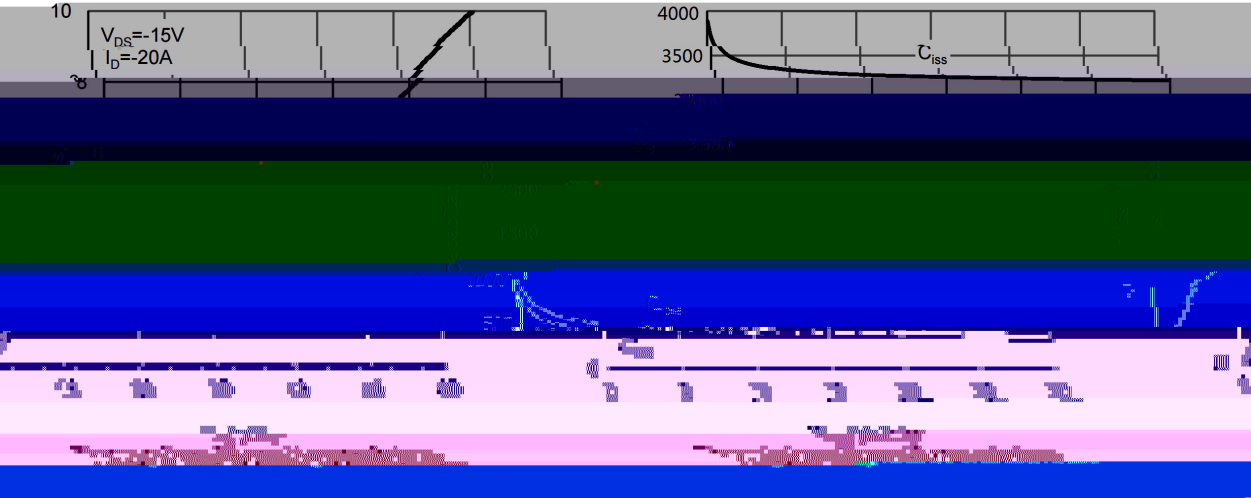
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/ Electrical Characteristics(Ta=25)

V_{DD}	I_N	I_{DD}	I_{DD}	I_{DD}	I_{DD}	I_{DD}
		I_{DD}				

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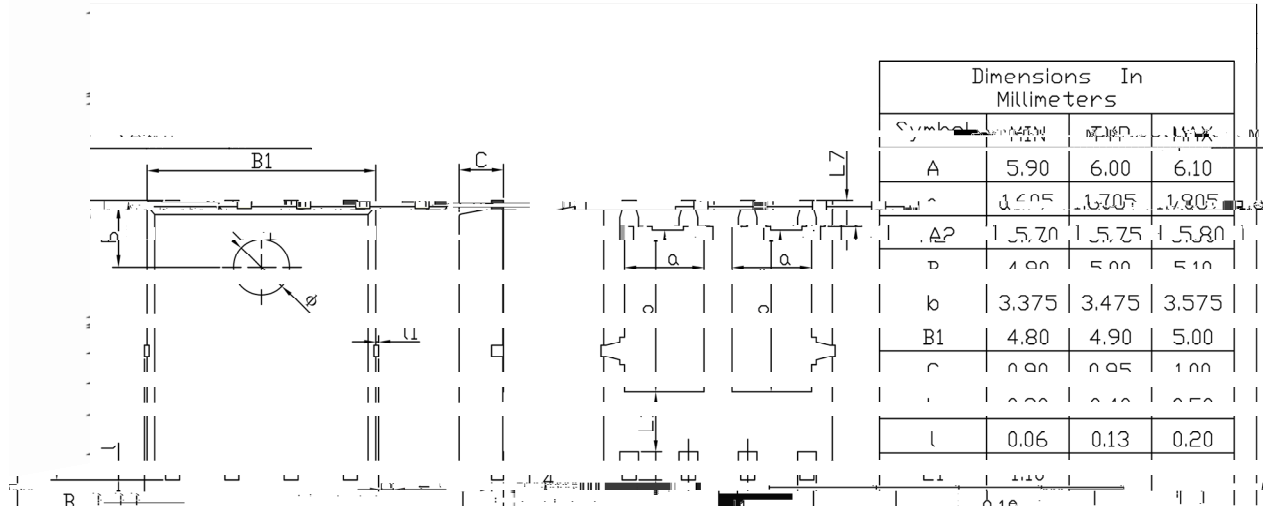
/ Electrical Characteristic Curve



/ Package Dimensions

N5 X6A

Unit:mm

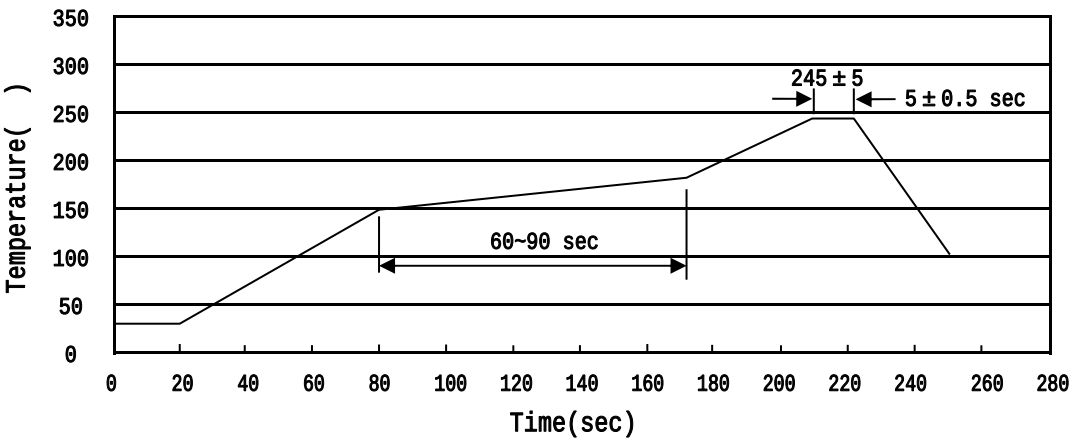


/ Marking Instructions



EU		

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



1. The temperature profile is for reference only. The actual temperature profile should be determined by the customer's requirements.

2. The temperature profile is for reference only. The actual temperature profile should be determined by the customer's requirements.

3. The temperature profile is for reference only. The actual temperature profile should be determined by the customer's requirements.

/ Resistance to Soldering Heat Test Conditions

1. The resistance to soldering heat test conditions is for reference only. The actual resistance to soldering heat test conditions should be determined by the customer's requirements.

2. The resistance to soldering heat test conditions is for reference only. The actual resistance to soldering heat test conditions should be determined by the customer's requirements.

/ Packaging SPEC.

1. The packaging specification is for reference only. The actual packaging specification should be determined by the customer's requirements.

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	Units/Reel E 2 0`	Reels/Inner Box 0` 2`	Units/Inner Box E 2`	Inner Boxes/Outer Box ` 2 1	Units/Outer Box E 2 1	Reel	Inner Box ``	Outer Box 1

/ Notices